HD31771
SOLID STATE HIGH POWER AMPLIFIER

FEATURES

Designed for EMC-EMI/RFI, Lab, and general comm applications
Compact Small form factor, light weight, high power density
Class A/AB linear advanced technology design
Instantaneous ultra-wide bandwidth
Suitable for all single channel modulation standards
Built-in protection circuits
High reliability and ruggedness



ELECTRICAL SPECIFICATIONS : 50Ω, 25°C

Parameter	Specification	Notes
Operating Frequency Range	2.0 - 6.0 GHz	
Power Output @ Psat	100 Watt Min	CW
Power Output @ P1dB	40 Watt Typ	CW
Power Gain	50 dB Min	0dBm or less for rated Pout
Power Gain Flatness	3.0 dB p-p Max	Constant input power
Input Return Loss	-10 dB Max	Relative to 50 Ohm
2-Tone Intermodulation (IMD)	-30 dBc Typ	40 dBm/Tone, Δ = 1 MHz
Harmonics	-20 dBc Typ	At rated Pout
Spurious	-60 dBc Max	Non-harmonics
Noise Figure	10 dB Max	
Operating Voltage	32 VDC Nom	
Current Consumption	24 Amp Max / <20 Amp Typ	At rated Pout
Input Power Protection	+8 dBm Max	<10 Sec without damage
Load VSWR Protection	5 : 1 Max	<1 minute at rated output
Turn On / Off Speed	5 µSec Max	Optional

ENVIRONMENTAL CHARACTERISTICS

Parameter	Specification	Notes
Operating Case Temperature	-20 to +75 °C	
Storage Temperature	-40 to +85 °C	
Relative Humidity	up to 95 %	Non-condensing
Altitude	3000 meters	
Shock & Vibration	Normal transport[1]	

1 MIL Spec available for quotation

MECHANICAL SPECIFICATIONS

Parameter	Specification	Notes
Dimensions	285 x 125 x 27mm	Excluding connectors
Weight	2.15 Kg.	
RF Connectors In/Out	SMA female	Option: TNC-F Output
DC Power / Interface Connector	7-Pin Hybrid D-Sub	
Cooling	External Heatsink	Forced air required

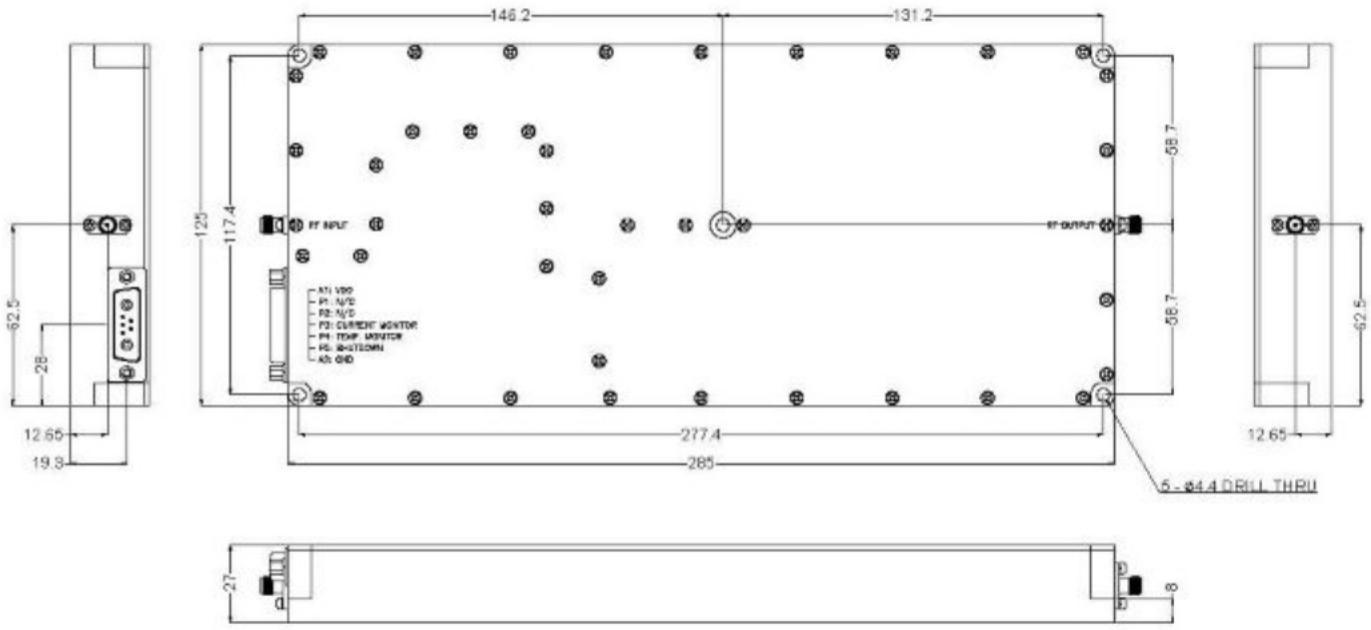
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Specifications subject to change without notice. Specifications and drawings may vary with selected options.

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D-SUB CONNECTOR PIN ASSIGNMENT

Pin	Function	Description
1	N/C	N/C
2	N/C	N/C
3	CURRENT SENSOR	I_D@20mV/100mA Typ
4	TEMP SENSOR	V_T@10mV/°C + 500mV Typ
5	SHUTDOWN	Enable = TTL High or Open; Disable = TTL Low or Short
A1	VDD	32VDC
A2	GND	Ground

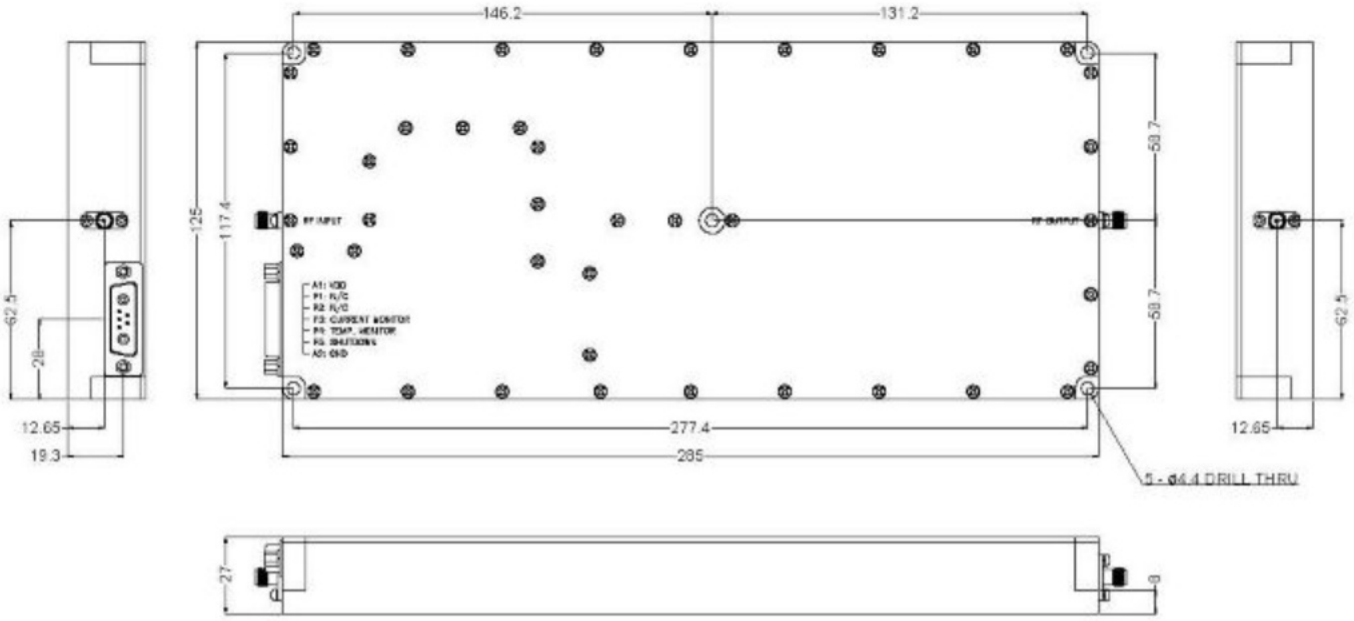
OUTLINE DRAWING



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OUTLINE DRAWING
WITH Option : TNC type Connector



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